

EddyCus® TF map 2530A – Anisotropy Imaging Device

P T 2530A 21



Highlights

- ► Contact-free imaging
- ► High speed (10,000 points in 5 min)
- ► Repeatable and accurate
- ► High resolution (9 to 90,000 points)
- ► Mapping of encapsulated layers
- ► Homogeneity and defect imaging

Device Series

- ► Metal thickness (nm, μm)
- ► Sheet resistance (Ohm/sq)
- Emissivity
- ► Conductivity / resistivity (mOhm·cm)
- ► Electrical anisotropy (%)
- ▶ Weight (g/m²) and drying status (%)
- ▶ Permeability (H/m) Beta

SURAGUS GmbH Maria-Reiche-Strasse 1 01109 Dresden Germany

For further questions: +49 351 32 111 520

sales@suragus.com

Visit us at: www.suragus.com www.suragus.com/calculator www.suragus.com/EddyCusMap2530

Applications

- ► Touch panel sensors (TPS)
- ► Printed electronics
- ▶ Wearable electronics
- ► Smart textiles
- ► Photovoltaics
- ► Smart / switchable films
- ► Medical surfaces and devices
- ► Biological sensors
- ► Aerospace, automotive, transportation
- ► Semiconductor and memory
- ► Energy storage

Materials

- ► Nanowire films
 - ► Conductive NW (Ag, Ni, Pt, Au)
 - ► Semiconductor NW (Si, SiC)
 - ► Magnetic NW (Fe₃O₄—AgNWs)
 - ► Multilayer NW (ZnO/AgNW/ZnO)
- ► Carbon Nano Tubes and Buds
- ► Fiber reinforced composites
- ► Metal meshes, smart meshes
- ► Anisotropic grain / domain materials
- Anisotropic effect / defect directions (cracks, line defects)

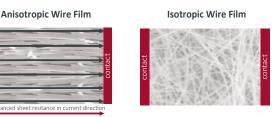
Engineered and Made in Germany





Anisotropy Term and Concept

- ► Electrical anisotropy refers to a difference in electrical resistance depending on the direction of current flow
- ▶ Wire and mesh structures can have anisotropic resistances
- ► Bulk materials with dominant directional characteristics / effects / defects can also have electrical anisotropy
- ► Anisotropy can be optimized to the layout of the contacts
- Anisotropy can save material and improve optical transparency to sheet resistance ratio



- ▶ Described by anisotropy direction and strength
- ▶ Both characteristics must be obtained at the same position
- ► The anisotropy strength is calculated using the lowest and highest resistance that align in perpendicular directions
- ► Inline deposition, e.g. slot die coating on moving web, tends to create lower resistances in machine direction "MD" and higher resistance in traversing direction "TD"
- ► Calculation as ratio of lowest and highest resistance



Device Characteristics

Measurement technology	Non-contact eddy current sensor with directed current induction
Substrates	Foils, glass, wafer, etc.
Max. scanning area	12 inch / 300 mm x 300 mm (larger upon request)
Max. sample thickness / sensor gap	3/5/10/25 mm (defined by the thickest sample / application)
Sheet resistance range	0.01 – 1,000 Ohm/sq; 1 to 5 % accuracy
Anisotropy range (TD/MD)	0.33 – 3 (larger upon request)
Scanning pitch	1 / 2.5 / 5 / 10 / 25 mm (other upon request)
Measurement points per time (square shaped samples)	10,000 measurement points in 5 minutes 1,000,000 measurement points in 30 minutes
Scanning time	8 inch / 200 mm x 200 mm in 1.5 to 15 minutes (1 – 10 mm pitch) 12 inch / 300 mm x 300 mm in 2 to 15 minutes (2.5 – 25 mm pitch)
Device dimensions (w/h/d) / weight	31.5" x 19.1" x 33.5" / 785 mm x 486 mm x 850 mm / 90 kg
Further available features	Metal thickness, sheet resistance, resistivity imaging

Device Control and Software

- Pre-defined measurement and product recipes (sizes, pitches, thresholds)
- ▶ Line scan, histogram and area analysis
- ▶ Black and colored image coding
- ► Csv & pdf export
- ▶ SPC summary and export
- ▶ 3 user levels
- ► Material database for parameter conversion
- ► Edge effect compensation
- ► Storage and import of data
- ► Export of data sets (e.g. to EddyEva, MS Excel, Origin)

